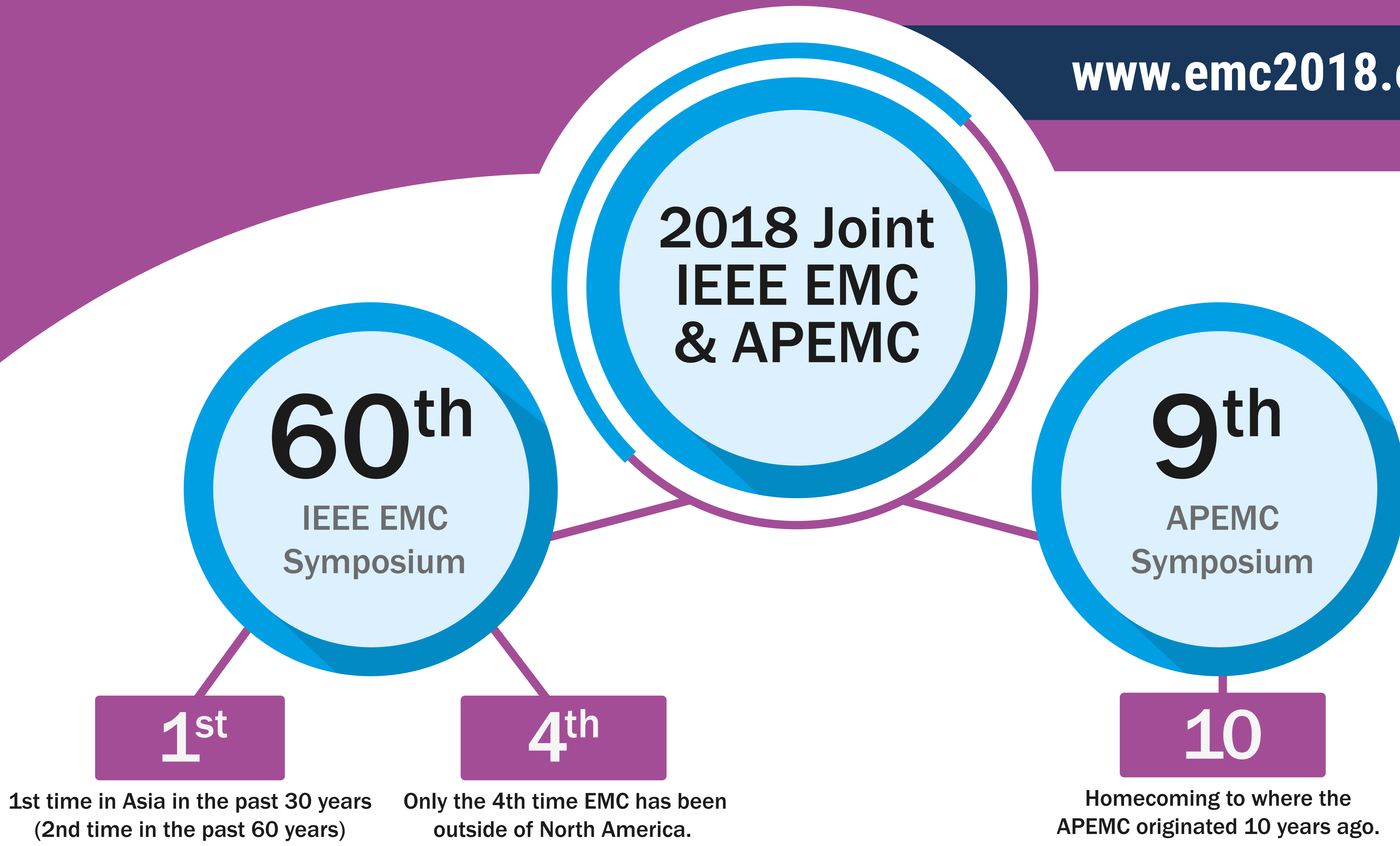




# 2018 JOINT IEEE INTERNATIONAL SYMPOSIUM ON ELECTROMAGNETIC COMPATIBILITY AND ASIA-PACIFIC SYMPOSIUM ON ELECTROMAGNETIC COMPATIBILITY

14-17 May 2018 • Suntec Convention & Exhibition Center, Singapore

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		PATH 1 Regular Papers	PATH 2 Special-Session Papers	With option to extend to 1-6 page full paper
OCT.			<b>14 Oct. 2017</b> Proposal submission ends.	<b>14 Oct. 2017</b> Proposal submission ends.
NOV.	<b>24 Nov. 2017</b> Paper submission ends.		<b>07 Nov. 2017</b> Proposal acceptance notice.	<b>07 Nov. 2017</b> Acceptance notice.
DEC.			<b>23 Dec. 2017</b> Paper submission ends.	
JAN.	<b>16 Jan. 2018</b> Paper acceptance notice.		<b>22 Jan. 2018</b> Paper review feedback.	<b>08 Jan. 2018</b> Abstract submission ends.
				<b>29 Jan. 2018</b> Paper acceptance notice.
		FINAL PAPERS DUE: 23 FEB. 2018		PRESENTATION MATERIALS DUE: 05 MAR. 2018

• All papers/abstracts presented during the symposium will be published in the symposium proceedings.  
• All full-papers presented during the symposium will be published online in the IEEE Xplore.  
• Abstract reviewed papers may be invited for submission to the IEEE EMC Magazine which is archived in the IEEE Xplore.

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